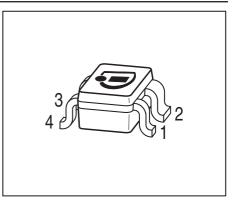


BFP183W

Low Noise Silicon Bipolar RF Transistor

- For low noise, high-gain broadband amplifiers at collector currents from 2 mA to 30 mA
- $f_{\rm T}$ = 8 GHz, $NF_{\rm min}$ = 0.9 dB at 900 MHz
- Pb-free (RoHS compliant) and halogen-free package with visible leads
- Qualification report according to AEC-Q101 available





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration					Package	
BFP183W	RHs	1=E	2=C	3=E	4=B	-	-	SOT343

Maximum Ratings at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CEO}	12	V
Collector-emitter voltage	V _{CES}	20	
Collector-base voltage	V _{CBO}	20	
Emitter-base voltage	V _{EBO}	2	
Collector current	I _C	65	mA
Base current	/ _B	5	
Total power dissipation ¹⁾	P _{tot}	450	mW
<i>T</i> _S ≤ 58 °C			
Junction temperature	TJ	150	°C
Storage temperature	T _{Sta}	-55 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R _{thJS}	205	K/W

 ${}^{1}T_{S}$ is measured on the collector lead at the soldering point to the pcb

²For the definition of R_{thJS} please refer to Application Note AN077 (Thermal Resistance Calculation)



Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
<i>I</i> _C = 1 mA, <i>I</i> _B = 0					
Collector-emitter cutoff current	I _{CES}	-	-	100	μA
$V_{\rm CE}$ = 20 V, $V_{\rm BE}$ = 0					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB}$ = 10 V, $I_{\rm E}$ = 0					
Emitter-base cutoff current	I _{EBO}	-	-	1	μA
$V_{\rm EB}$ = 1 V, $I_{\rm C}$ = 0					
DC current gain	h _{FE}	70	100	140	-
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, pulse measured					

Electrical Characteristics at T_A = 25 °C, unless otherwise specified



Parameter	Symbol		Values		
		min.	typ.	max.	
AC Characteristics (verified by random samplin	g)			1	
Transition frequency	f _T	6	8	-	GHz
$I_{\rm C}$ = 25 mA, $V_{\rm CE}$ = 8 V, f = 500 MHz					
Collector-base capacitance	C _{cb}	-	0.34	0.54	pF
$V_{\rm CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{\rm BE} = 0$,					
emitter grounded					
Collector emitter capacitance	C _{ce}	-	0.27	-	
$V_{\rm CE}$ = 10 V, f = 1 MHz, $V_{\rm BE}$ = 0,					
base grounded					
Emitter-base capacitance	C _{eb}	-	1.1	-	
$V_{\rm EB}$ = 0.5 V, <i>f</i> = 1 MHz, $V_{\rm CB}$ = 0 ,					
collector grounded					
Minimum noise figure	NF _{min}				dB
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
<i>f</i> = 900 MHz		-	0.9	-	
<i>f</i> = 1.8 GHz		-	1.4	-	
Power gain, maximum stable ¹⁾	G _{ms}	-	22	-	dB
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,					
<i>f</i> = 900 MHz					
Power gain, maximum available ¹⁾	G _{ma}	-	15.5	-	dB
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,					
<i>f</i> = 1.8 GHz					
Transducer gain	S _{21e} ²				dB
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
<i>f</i> = 900 MHz		-	17.5	-	
<i>f</i> = 1.8 GHz		-	11.5	-	

Electrical Characteristics at T_A = 25 °C, unless otherwise specified

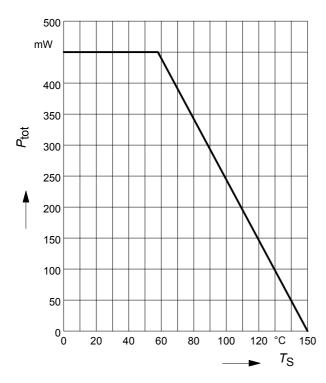
 ${}^{1}G_{\mathsf{ma}} = |S_{21\mathrm{e}} \ / \ S_{12\mathrm{e}}| \ (\mathsf{k}\text{-}(\mathsf{k}^{2}\text{-}1)^{1/2}), \ G_{\mathsf{ms}} = |S_{21} \ / \ S_{12}|$



BFP183W

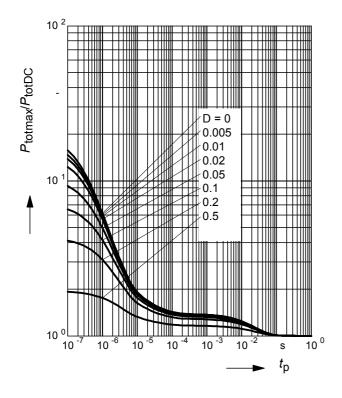
Total power dissipation $P_{tot} = f(T_S)$

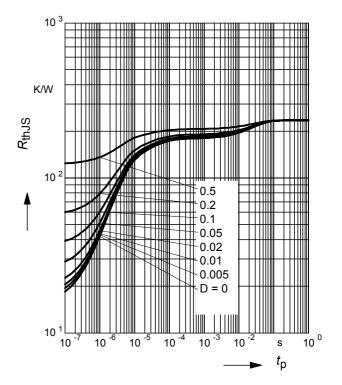
Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$



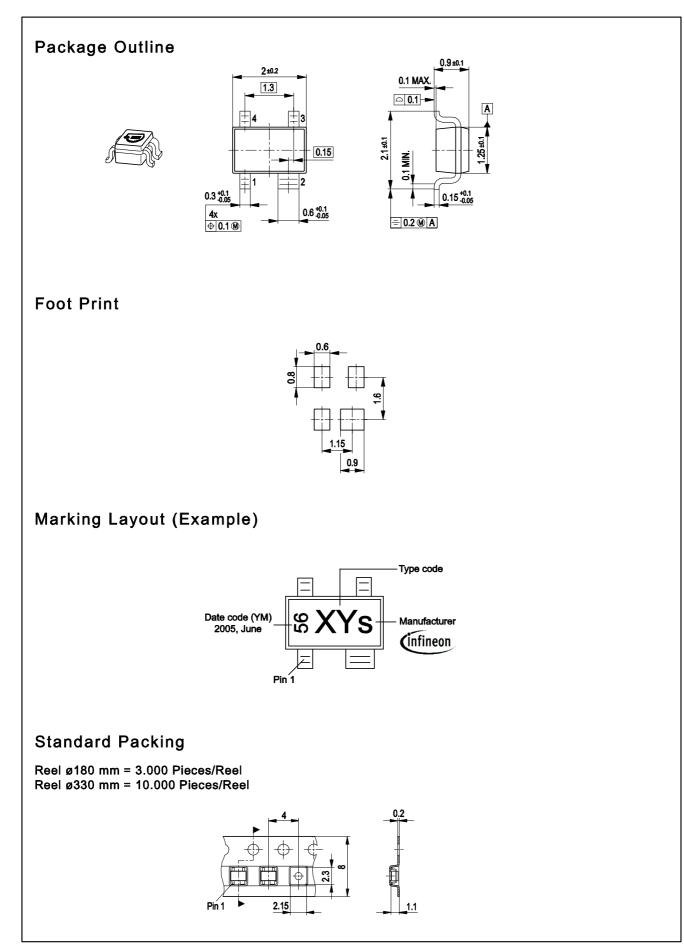
Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$











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